

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JORG BEHRENS	06/22/2006
RECEIVING PARTY DATA	
Name:	Koninklijke Philips Electronics N.V.
Street Address:	Groenewoudseweg 1
City:	Eindhoven
State/Country:	NETHERLANDS
Postal Code:	5621 BA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	8013452
CORRESPONDENCE DATA	
Fax Number:	(408)518-5671
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	3474431592
Email:	david.schaeffer@nxp.com
Correspondent Name:	DAVID L. SCHAEFFER
Address Line 1:	411 EAST PLUMERIA DRIVE, MS41
Address Line 2:	NXP SEMICONDUCTORS, IP&L
Address Line 4:	SAN JOSE, CALIFORNIA 95134
NAME OF SUBMITTER:	DAVID L. SCHAEFFER
SIGNATURE:	/David L. Schaeffer/
DATE SIGNED:	10/02/2017
Total Attachments: 1	
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For good and valuable consideration, of which I acknowledge receipt, I, as a below-named assignor, sell and assign to Koninklijke Philips Electronics N.V. (hereinafter "Assignee") a corporation existing under the laws of the Kingdom of the Netherlands, whose business address is Groenewoudseweg 1, 5621 BA Eindhoven, The Netherlands, its successors and assigns, the application for a United States Patent for the improvements in a **Wire-bonded semiconductor component with reinforced inner connection metallization** invented by us, which application:

- is executed concurrently herewith
- was executed by me/us on
- is Serial No. filed
- is International Application No. PCT/IB2004/052628 filed December 1, 2004,

and all rights in and to said application, and all Patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all Patents on said improvements or resulting therefrom to said Assignee as assignee of the entire interest and covenant that I have full right so to do, and agree that I will communicate to said Assignee or its representatives any facts known to me respecting said improvements and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Assignee, its successors, assigns and nominees, to obtain and enforce proper protection for said invention.

22.06.06 (sign name here) Jörg Behrens , Assignor
 Date (print name here) Jörg BEHRENS